

2823

TSMC00-488

March 31 2003



To: Commissioner of Patents and Trademarks
Washington, D.C. 20231

3/31/03

ATTN: GROUP ART UNIT 2823 W. D. COLEMAN

FR: Stephen B. Ackerman Reg. No. 37761
28 Davis Avenue
Poughkeepsie
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#7/A
Andt
J. McMillan
4/11/03

Subject:

Serial No. 09/863,223	05/24/01
"Prevention of post CMP defects in Cu FSG process"	
C-S Liu and S-L Shue	
Grp. Art Unit : 2823	W. D. Coleman

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RESPONSE TO PATENT OFFICE ACTION

Dear Sir:

In response to the Office Action dated December 31 2002, in the above identified application for patent, please enter the following amendments and consider the following remarks.

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner of Patents and Trademarks, Washington, D.C. 20231 on March 31 2003.

Name Stephen B. Ackerman, Reg #37761
Signature/Date [Signature] 3/31/03